

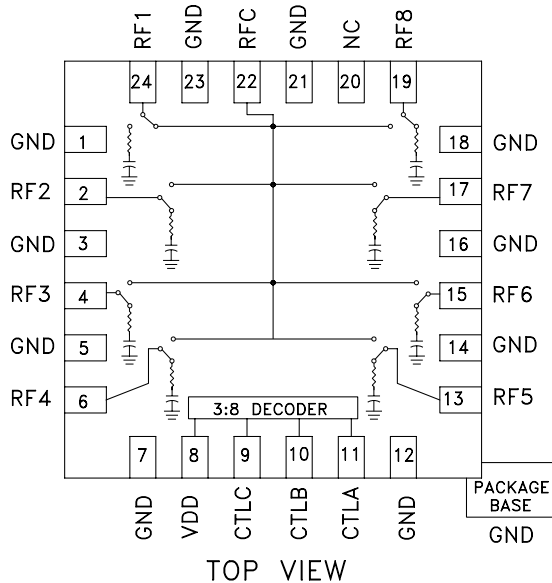
## GaAs MMIC SP8T NON-REFLECTIVE POSITIVE CONTROL SWITCH, DC\* - 8.0 GHz

### Typical Applications

This switch is suitable for usage in DC - 8.0 GHz 50-Ohm or 75-Ohm systems:

- Broadband
- Fiber Optics
- Switched Filter Banks
- Wireless below 8 GHz

### Functional Diagram



### Features

- Broadband Performance: DC - 8.0 GHz
- High Isolation: >30 dB@ 6 GHz
- Low Insertion Loss: 2.5 dB@ 6 GHz
- Integrated Positive Supply 3:8 TTL Decoder
- 4 mm x 4 mm x 1 mm SMT Package

### General Description

The HMC321LP4 is a broadband non-reflective GaAs MESFET SP8T switch in a low cost leadless surface mount package. Covering DC to 8 GHz, this switch offers high isolation and low insertion loss. This switch also includes an on board binary decoder circuit which reduces the required logic control lines to three. The switch operates using a positive control voltage of 0/+5 volts, and requires a fixed bias of +5v. This switch is suitable for usage in 50-Ohm or 75-Ohm systems.

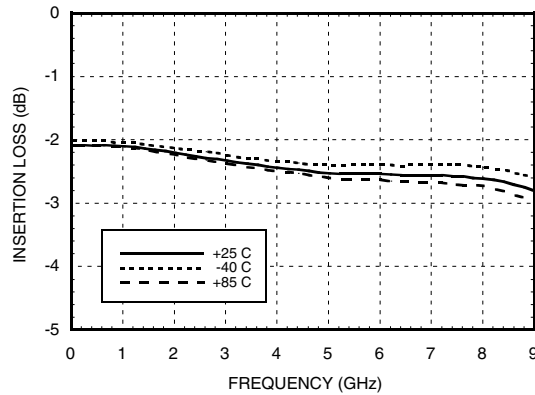
\* DC blocking capacitors are required at ports RFC and RF1, 2, 3, 4, 5, 6, 7, 8. Their value will determine the lowest transmission frequency.

### Electrical Specifications, $T_A = +25^\circ C$ , With 0/+5V Control, 50 Ohm System

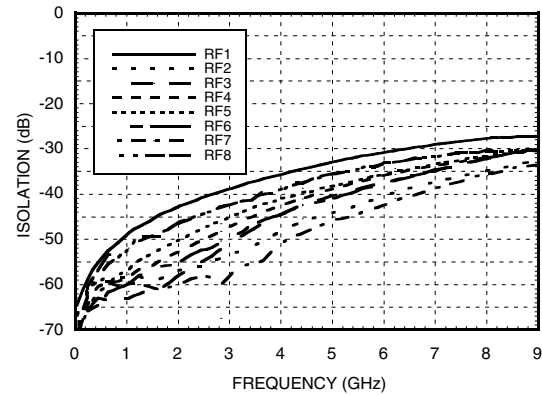
Parameter	Frequency	Min.	Typ.	Max.	Units
Insertion Loss	DC - 2.0 GHz		2.3	2.7	dB
	DC - 4.0 GHz		2.5	2.9	dB
	DC - 8.0 GHz		2.7	3.1	dB
Isolation	DC - 2.0 GHz	35	40		dB
	DC - 4.0 GHz	30	35		dB
	DC - 6.0 GHz	25	30		dB
	DC - 8.0 GHz	20	25		dB
Return Loss	"On State"	DC - 4.0 GHz	8	12	dB
		DC - 8.0 GHz	7	10	dB
Return Loss (RF1 - RF8)	"Off State"	2.0 - 8.0 GHz	7	12	dB
Input Power for 1 dB Compression	0.5 - 8.0 GHz	19	23		dBm
Input Third Order Intercept (Two-tone Input Power = +7 dBm Each Tone, 1 MHz Spacing)	0.5 - 8.0 GHz	33	40		dBm
Switching Characteristics	DC - 8.0 GHz	tRISE, tFALL (10/90% RF)	50		ns
		tON, tOFF (50% CTL to 10/90% RF)	150		ns

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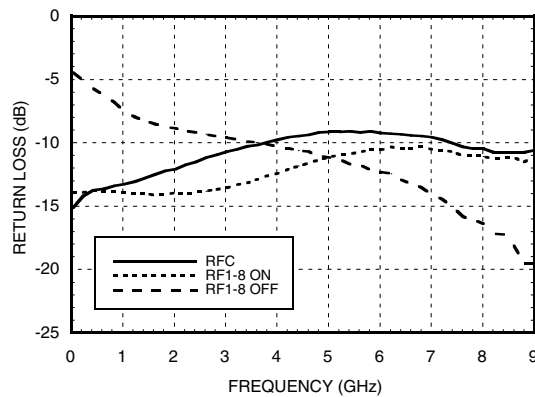
**Insertion Loss vs. Temperature**



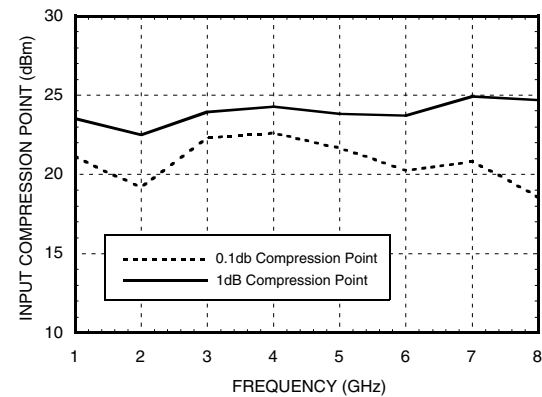
**Isolation**



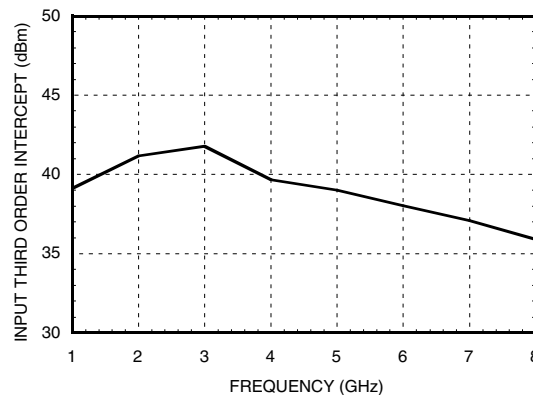
**Return Loss**



**0.1 and 1 dB Input Compression Point**



**Input Third Order Intercept Point**



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SWITCHES - SMT

## GaAs MMIC SP8T NON-REFLECTIVE POSITIVE CONTROL SWITCH, DC - 8.0 GHz

### Bias Voltage & Current

Vdd Range = +5.0 Vdc ± 10%		
Vdd (Vdc)	Idd (Typ.) (mA)	Idd (Max.) (mA)
+5.0	5.0	9.0

### Control Voltages

State	Bias Condition
Low	0 to +0.8 Vdc @ 5 uA Typical
High	+2.0 to +5.0 Vdc @ 25 uA Typical

### Truth Table

Control Input			Signal Path State
A	B	C	RFCOM to:
Low	Low	Low	RF1
High	Low	Low	RF2
Low	High	Low	RF3
High	High	Low	RF4
Low	Low	High	RF5
High	Low	High	RF6
Low	High	High	RF7
High	High	High	RF8

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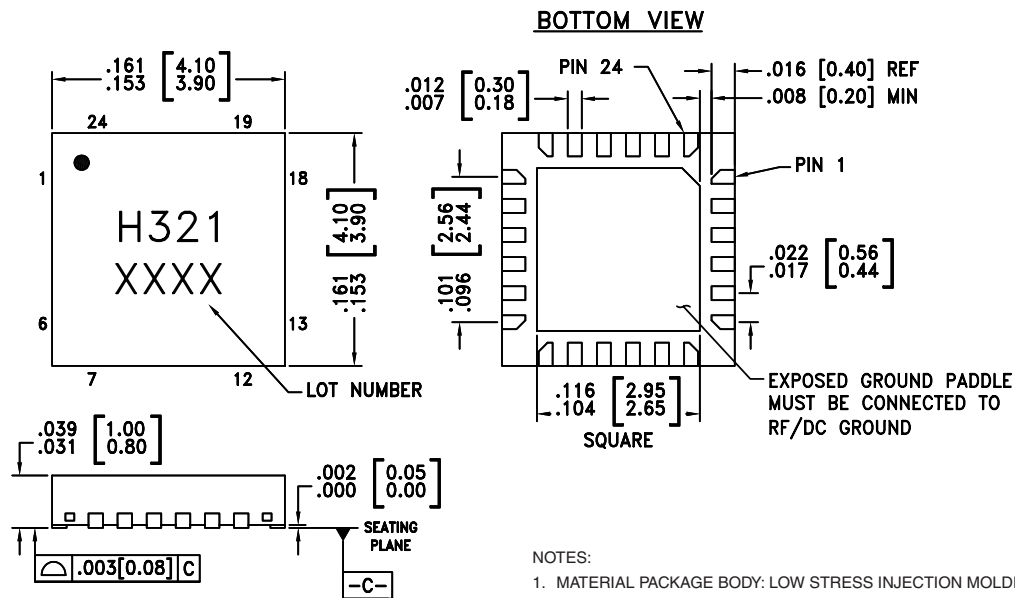
### Absolute Maximum Ratings

Bias Voltage Range (Port Vdd)	+7.0 Vdc
Control Voltage Range (A, B, & C)	-0.5V to Vdd +1.0 Vdc
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
Maximum Input Power Vdd = +5V	+26 dBm

**Note:**

DC blocking capacitors are required at ports RFC and RF1, 2, 3, 4, 5, 6, 7, 8. Their value will determine the lowest transmission frequency.

### Outline Drawing

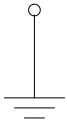
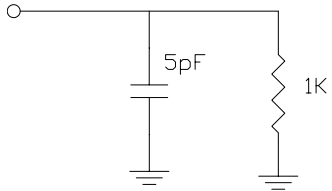
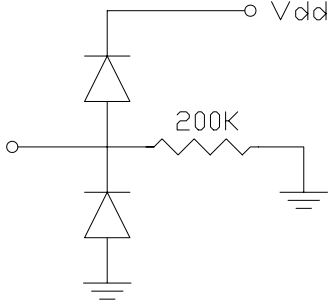


**NOTES:**

1. MATERIAL PACKAGE BODY: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
2. LEAD AND GROUND PADDLE MATERIAL: COPPER ALLOY
3. LEAD AND GROUND PADDLE PLATING: Sn/Pb SOLDER
4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
5. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
6. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.  
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
7. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
8. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
9. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED PCB LAND PATTERN.

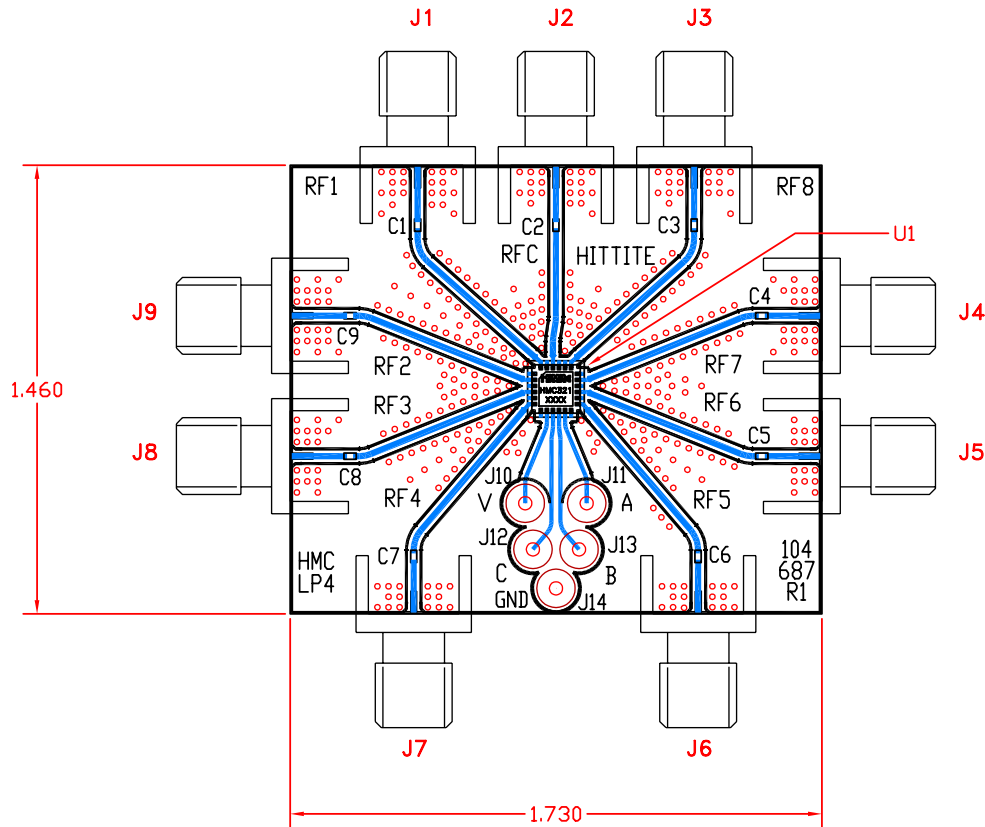
## *GaAs MMIC SP8T NON-REFLECTIVE POSITIVE CONTROL SWITCH, DC - 8.0 GHz*

### *Pin Descriptions*

Pin Number	Function	Description	Interface Schematic
1, 3, 5, 7, 12, 14, 16, 18, 21, 23	GND	Package bottom has exposed metal paddle that must also be connected to PCB RF ground.	
2, 4, 6, 13, 15, 17, 19, 22, 24	RF1 - RF8 & RFC	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required.	
8	VDD	Supply Voltage +5V ± 10%	
9	CTL C	See truth table and control voltage table.	
10	CTL B	See truth table and control voltage table.	
11	CTL A	See truth table and control voltage table.	
20	N/C	This pin should be connected to PCB RF ground to maximize isolation.	

## GaAs MMIC SP8T NON-REFLECTIVE POSITIVE CONTROL SWITCH, DC - 8.0 GHz

### Evaluation PCB



### List of Material

Item	Description
J1 - J9	PC Mount SMA RF Connector
J10 - J14	DC Pin
C1 - C9	100 pF Capacitor, 0402 Pkg.
U1	HMC321LP4 SP8T Switch
PCB*	104687 Evaluation PCB 1.73" x 1.46"
* Circuit Board Material: Rogers 4350	

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.